WS2[redacted]

1.F5[redacted]

The F5[redacted]

dri[redacted]

目录

电性参数

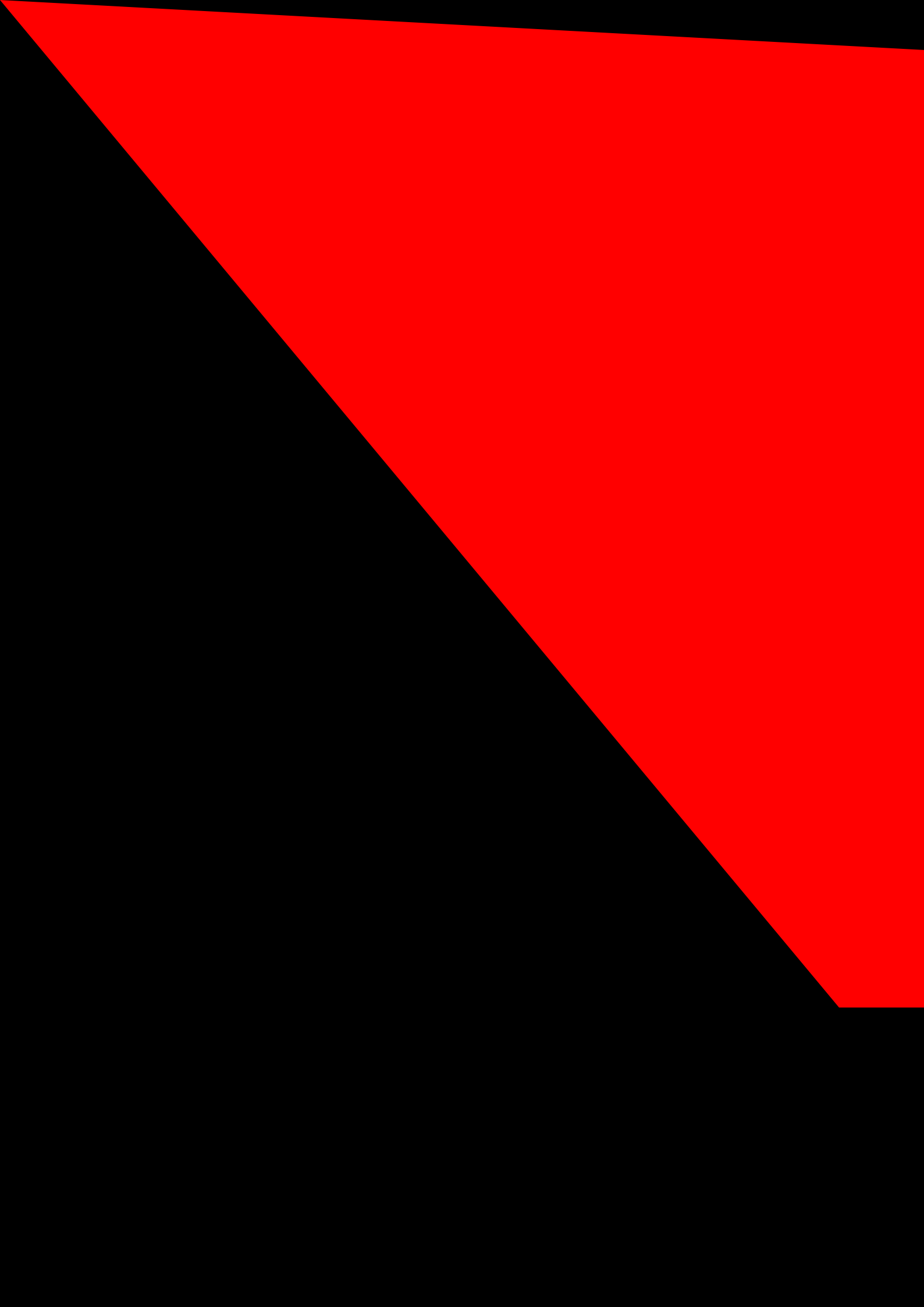
曲型特性曲线

可靠性实验

外形尺寸

包装

使用注意事项



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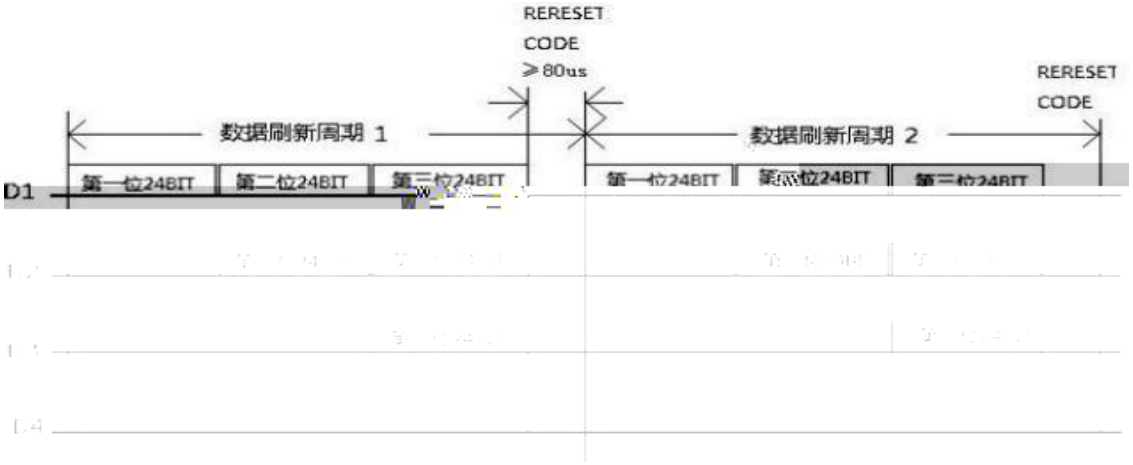
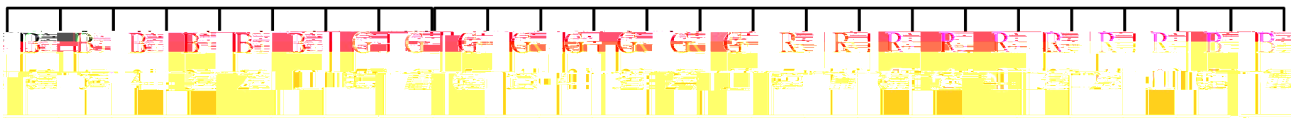


D1 MCU D2 D3 D4

Note: D1 refers to the data sent by MCU, and D2, D3 and D4 refer to the data automatically shaped and forwarded by cascade circuit

24bit



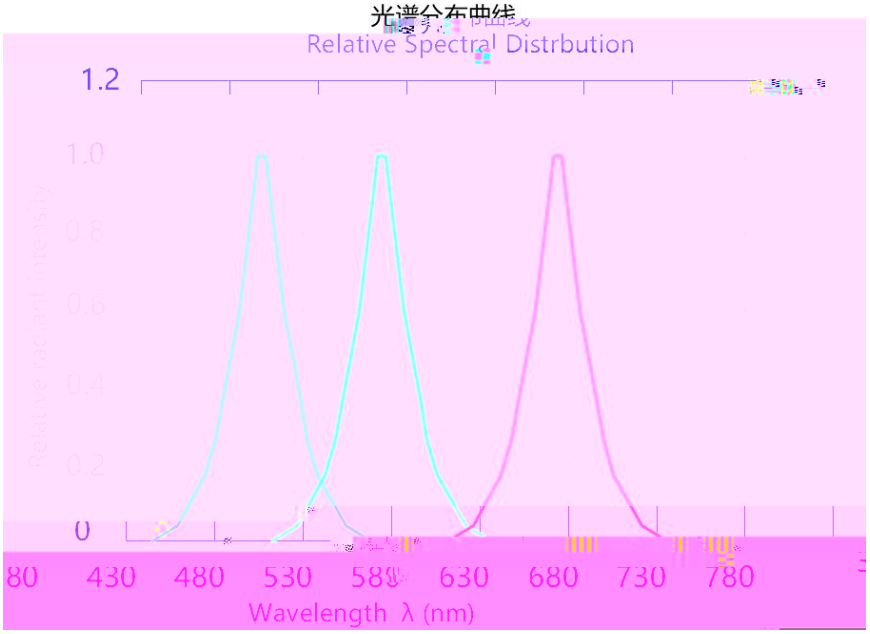
GRB

Note: high order first send, send data in the order of GrB

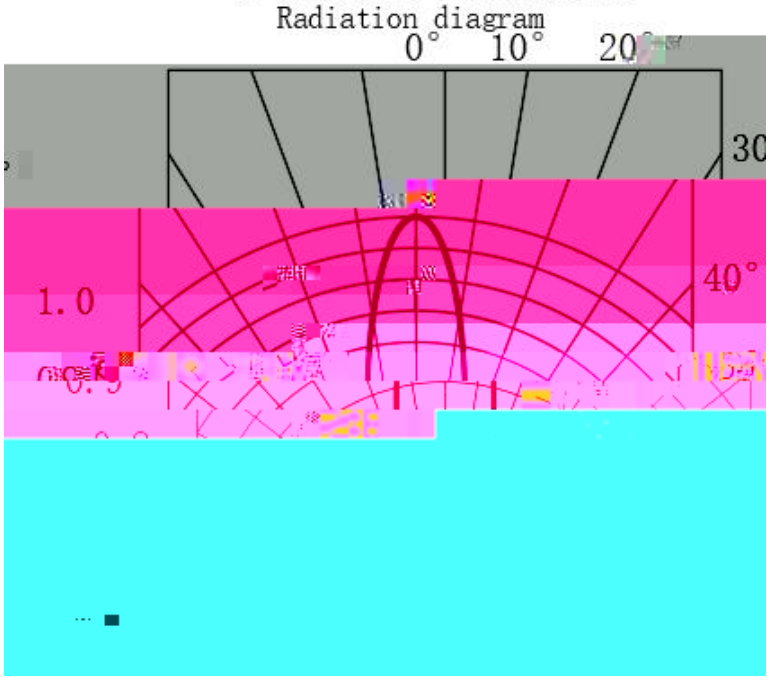
典型特性曲线

Typical Characteristics Curves

光谱分布曲线



相对辐射强度与空间角度关系

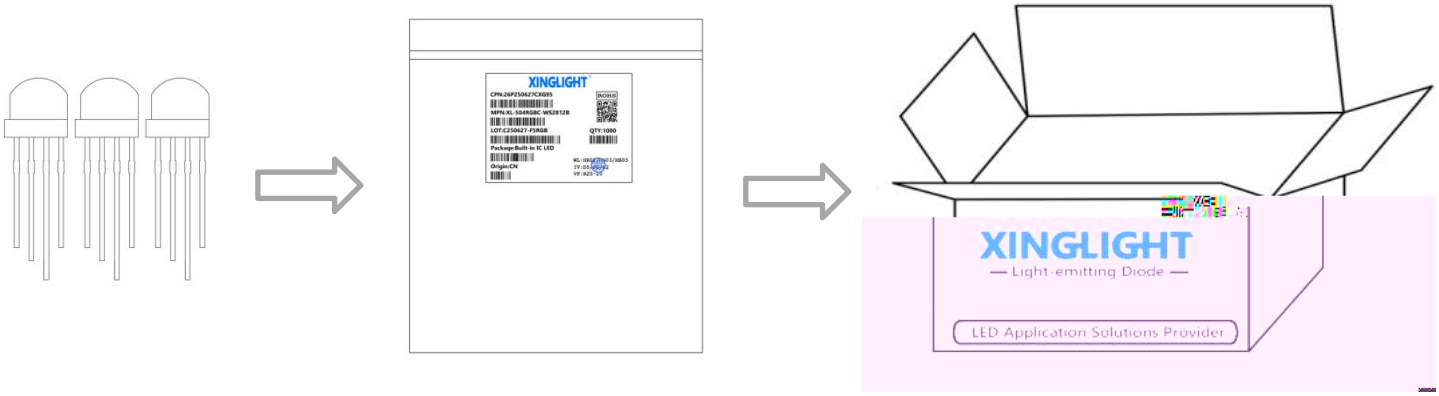
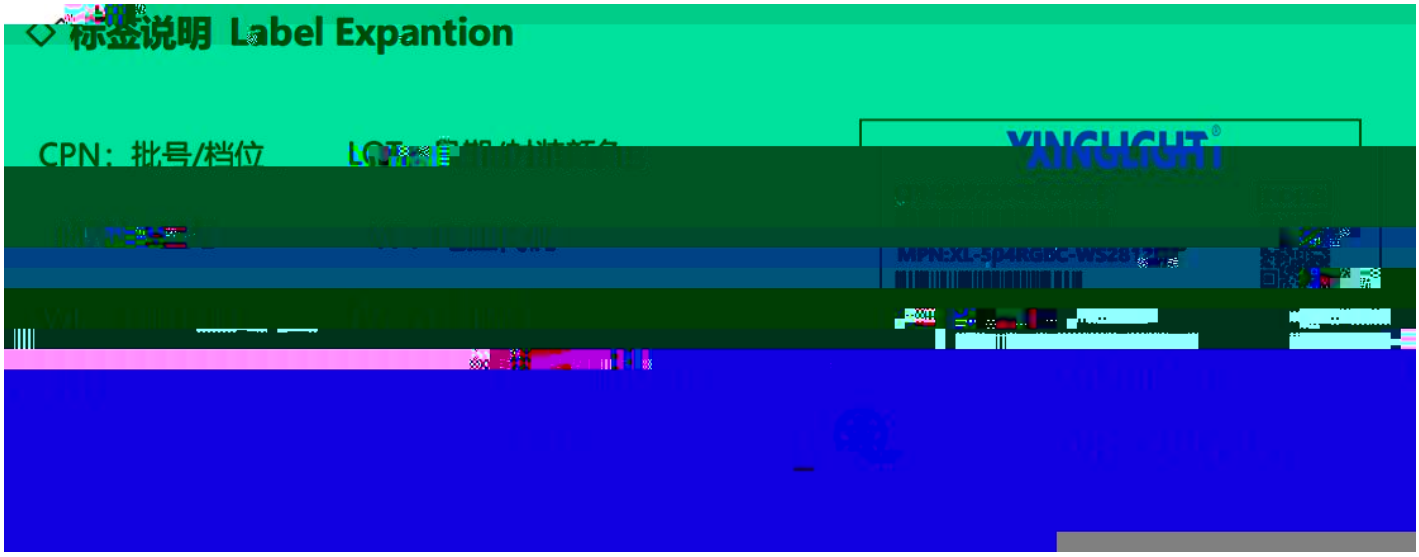
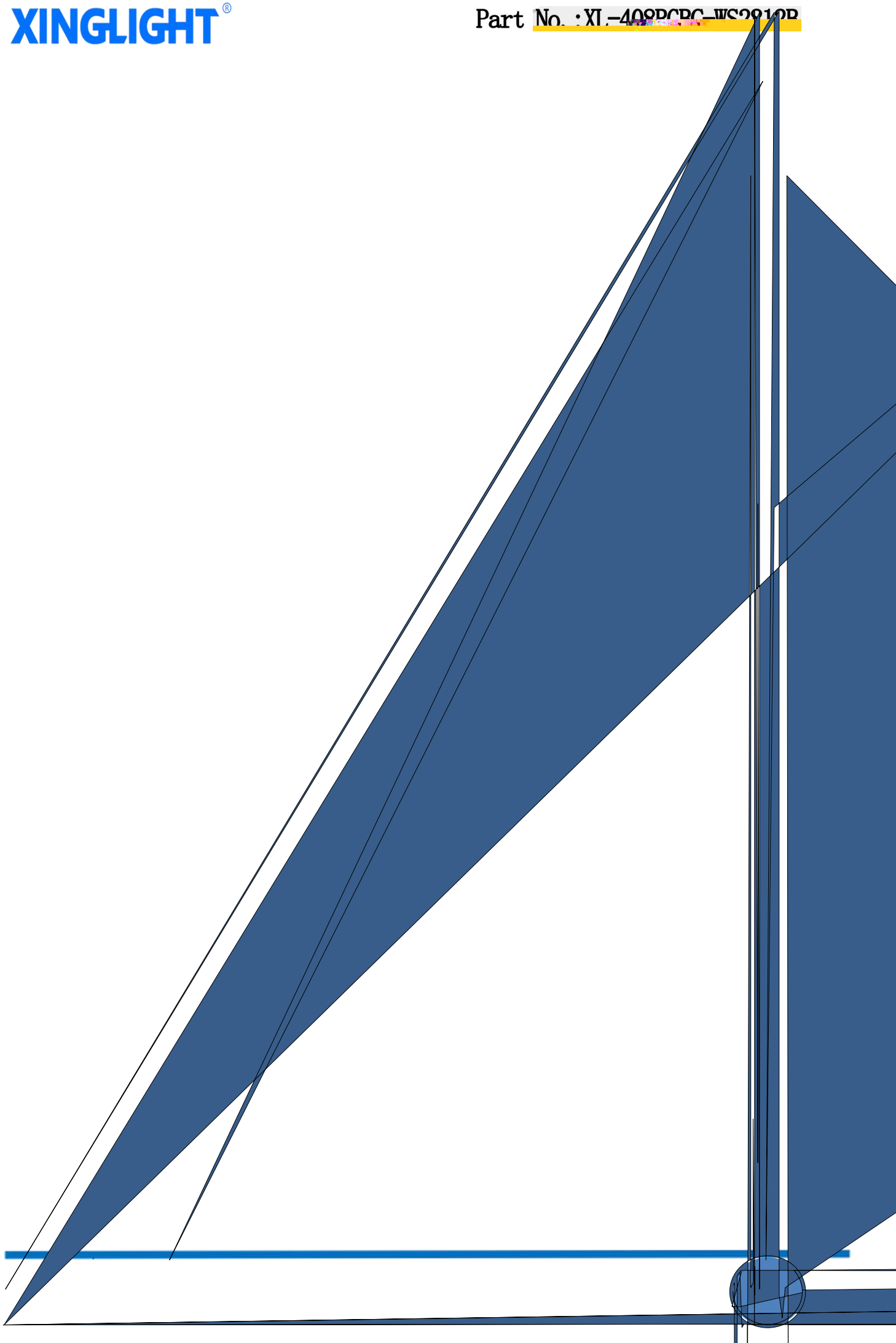


包装

Packaging

*

In Bags

*

Moisture Proof and Anti-Electrostatic Foil Bag